

FQP24N08 N-Channel QFET[®] MOSFET 80 V, 24 A, 60 mΩ

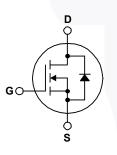
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 24 A, 80 V, $R_{DS(on)}$ = 60 m Ω (Max.) @V_{GS} = 10 V, I_{D} = 12 A
- Low Gate Charge (Typ. 19 nC)
- Low Crss (Typ. 50 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter	FQP24N08	Unit	
V _{DSS}	Drain-Source Voltage	80	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		24	A
	- Continuous (T _C = 100°C)		17	A
I _{DM}	Drain Current - Pulsed	(Note 1)	96	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	230	mJ
I _{AR}	Avalanche Current	(Note 1) 24		A
E _{AR}	Repetitive Avalanche Energy (Note 1)		7.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.5	V/ns
P _D	P _D Power Dissipation ($T_C = 25^{\circ}C$)		75	W
	- Derate above 25°C	0.5	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

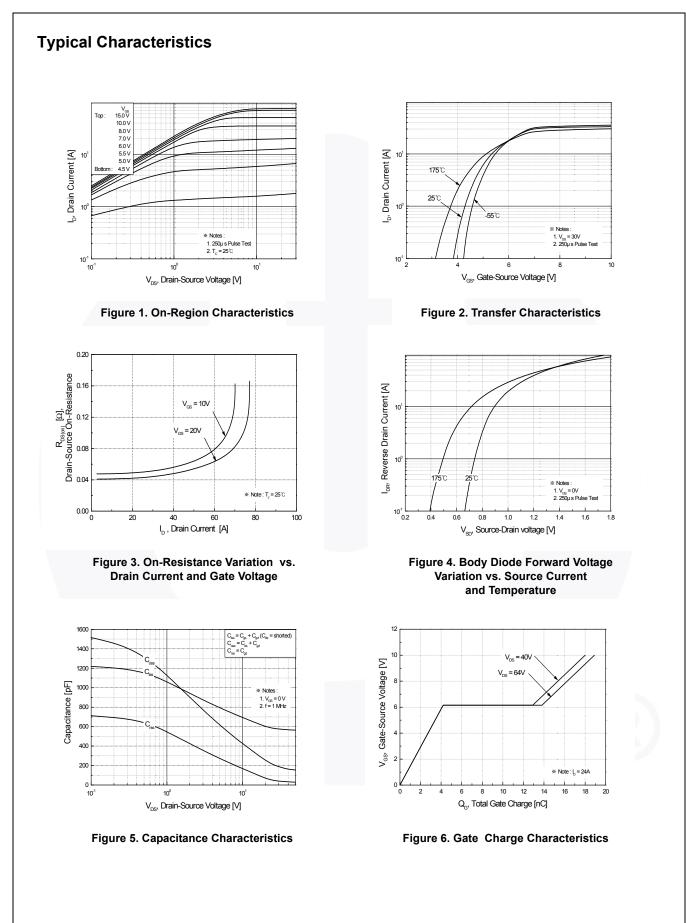
Thermal Characteristics

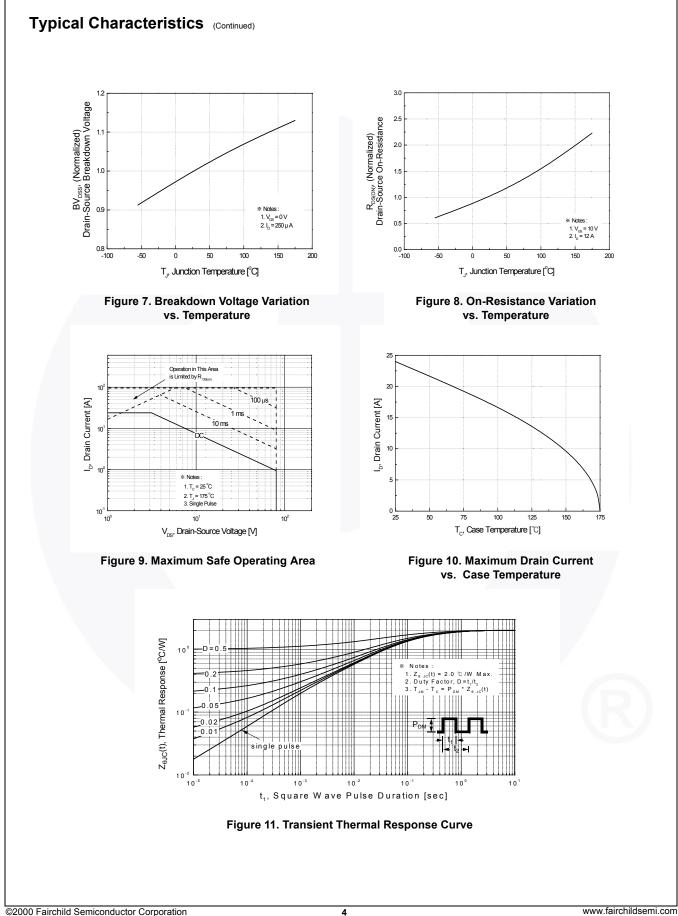
Symbol	Parameter	FQP24N08	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.0	°C/W	
R _{θJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

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Part NumberTop MarkIFQP24N08FQP24N08		Package	Packing Method	Reel Size	Tape Width		n Q	Quantity	
		TO-220	Tube N/A		N/A		50 units		
lectri	cal Char	acteristics T _c = 25	5°C unless other	wise noted.					
Symbol		Parameter	Test Conditions		ions	Min	Тур	Max	Unit
	racteristi	~~							
		ce Breakdown Voltage		V _{GS} = 0 V, I _D = 250 µ	. ^	80			V
BV _{DSS} ABV _{DSS}	Dialii-Soul	ce breakuown vollage		$v_{GS} = 0 v, I_D = 230 \mu$	IA	00			v
ΔDV_{DSS} / ΔT_{J}	Breakdown	Voltage Temperature Coe	fficient	$I_D = 250 \ \mu$ A, Referenced to 25°C			0.08		V/°C
DSS	Zero Gate	Voltage Drain Current		V_{DS} = 80 V, V_{GS} = 0				1	μA
	Zero Gale	voltage Drain Guirent		V _{DS} = 64 V, T _C = 150				10	μA
GSSF	Gate-Body	Leakage Current, Forward		V_{GS} = 25 V, V_{DS} = 0				100	nA
GSSR	Gate-Body	Leakage Current, Reverse	9	V_{GS} = -25 V, V_{DS} = 0	V			-100	nA
On Cha	racteristi	cs							
V _{GS(th)}	1	shold Voltage		V _{DS} = V _{GS} , I _D = 250	μA	2.0		4.0	V
R _{DS(on)}	Static Drair On-Resista	n-Source		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$			0.048	0.06	Ω
9 _{FS}		ansconductance		V _{DS} = 30 V, I _D = 12 A	4		12		S
Dynam C _{iss}	ic Charac Input Capa			V = 25 V V = 0	V		580	750	pF
C _{oss}	Output Cap			V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			210	270	pF
C _{rss}		ansfer Capacitance					50	65	pF
	ing Chara	cteristics				1	1		
t _{d(on)}	Turn-On De						10	30	ns
t _r	Turn-On Ri			V_{DD} = 40 V, I _D = 24 A, R _G = 25 Ω (Note 4)			105	220	ns
d(off)	Turn-Off De						30	70	ns
t _f	Turn-Off Fa	,					35	80	ns
Q _g	Total Gate			V _{DS} = 64 V, I _D = 24 A	١		19	25	nC
∽g Q _{gs}	Gate-Source	0		$V_{DS} = 64 \text{ V}, \text{ I}_{D} = 24 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)			4.2		nC
Q _{gd}	Gate-Drain						9.6		nC
gu							0.0		
		ode Characteristics		•					
S	Maximum Continuous Drain-Source Diode Forward Current						24	A	
SM	Maximum Pulsed Drain-Source Diode Forward Cu						96	A	
√ _{SD}		ce Diode Forward Voltage		V _{GS} = 0 V, I _S = 24 A				1.5	V
rr		ecovery Time		V _{GS} = 0 V, I _S = 24 A,			63		ns
Q _{rr}	Reverse R	ecovery Charge		dI _F / dt = 100 A/µs			130		nC

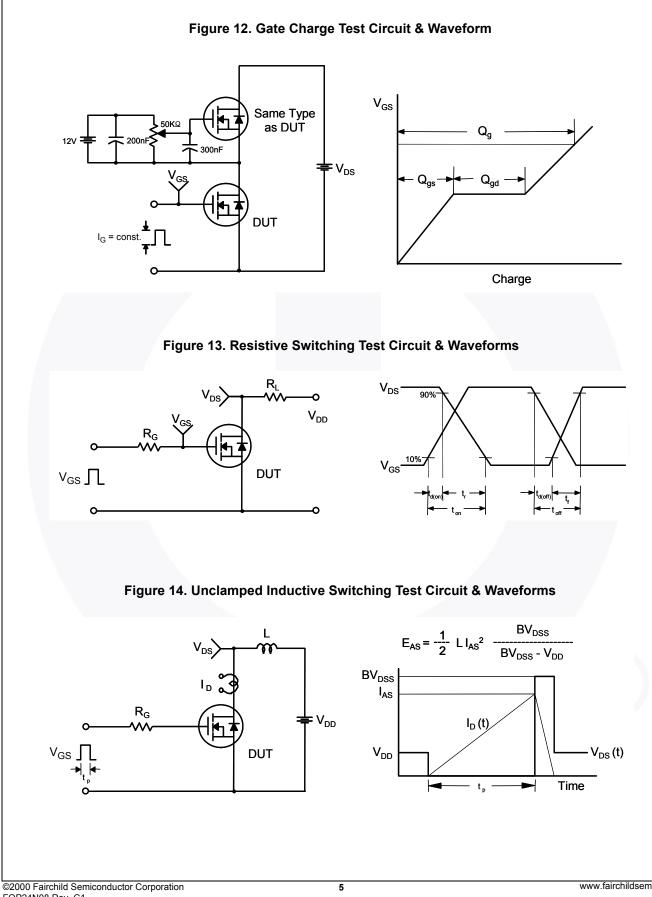
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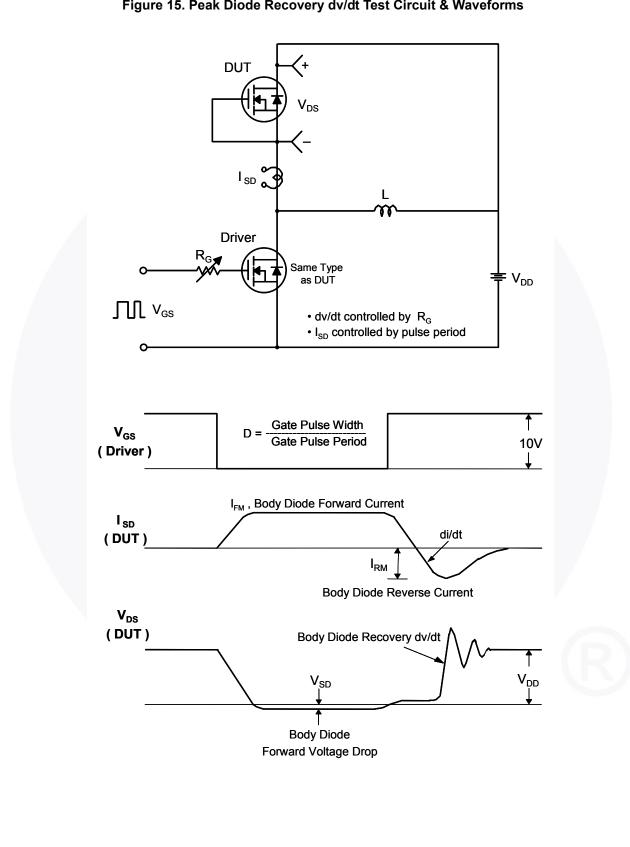


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

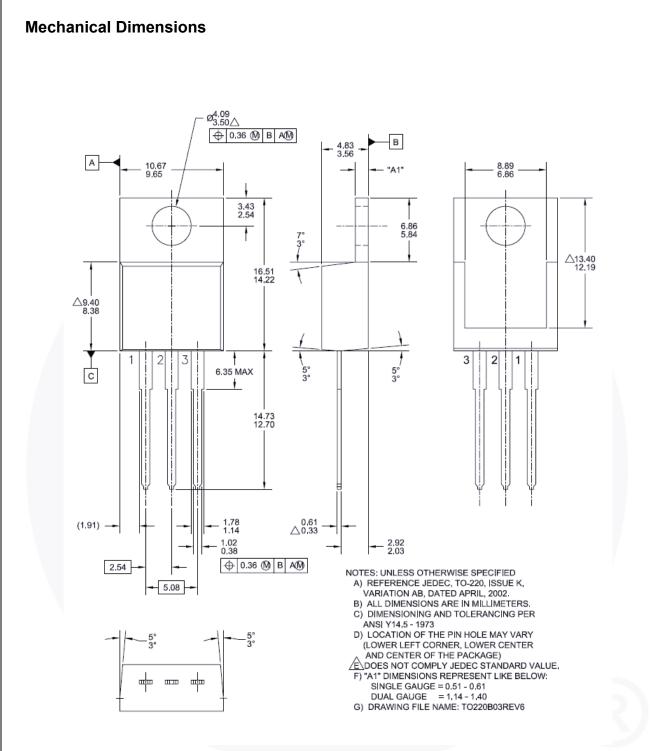


Figure 16. TO-220, Molded, 3-Lead, Jedec Variation AB

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Dimension in Millimeters

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